<table>
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<th>All layers viewed from top side</th>
<th>Board A: SHOXXED</th>
<th>REV E2</th>
<th>Same rev not in VersionControl</th>
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<td>LAYER NAME = Design Information</td>
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<td></td>
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<tr>
<td>PLOT NAME = Board Display</td>
<td>GENERATED 1/22/2014 4:04:29 PM</td>
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<td>TEXAS INSTRUMENTS</td>
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